51.12

Layer Name	Туре	Material	Thickness (mm)	Color
F.Silkscreen	Top Silk Screen	Not specified	0 mm	White
F.Paste	Top Solder Paste		0 mm	
F.Mask	Top Solder Mask	Not specified	0.01 mm	Black
F.Cu	copper		0.018 mm	
Dielectric	core	FR4-TG150	1.514 mm	Not specified
B.Cu	copper		0.018 mm	
B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Black
B.Paste	Bottom Solder Paste		0 mm	
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	White

BOARD CHARACTERISTICS

Copper Layer Count: 2 Board Thickness: 1.5700 mm

Board overall dimensions: 51.1200 mm x 45.6200 mm

Min track/spacing: 0.2000 mm / 0.1500 mm Min hole diameter: 0.2540 mm

Copper Finish: ENIG Impedance Control: No Castellated pads: No Plated Board Edge: No

Edge card connectors: No

Drawn by: Heath Raftery Company: Empirical.EE

Blues Inc

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Sheet:

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Title: Notecarrier-B

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